


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	[CHIP PACKAGE STRUCTURE AND PROCESS FOR FABRICATING THE SAME]		
Application Type : regular, utility Attorney Docket Number : 11846-US-PA			
Correspondence address: Customer Number: 31561 			
Priority Data: Doc.No: 2003-117506; Country -JP ; Date: 2003-04-22 us-priority-claimed Doc.No: 92129523; Country -TW ; Date: 2003-10-24 us-priority-claimed			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.